DB2J209

Silicon epitaxial planar type

For high frequency rectification DB3X209K in SMini2 type package

■ Features

- ullet Short reverse recovery time t_{rr}
- ullet Low forward voltage V_F
- Halogen-free / RoHS compliant
 (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

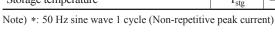
■ Marking Symbol: BE

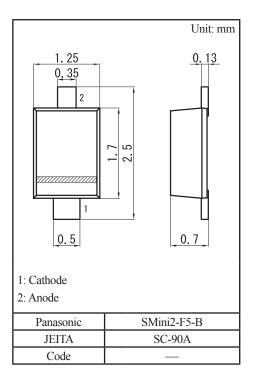
Packaging

DB2J20900L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V _R	20	V	
Repetitive peak reverse voltage	V _{RRM}	20	V	
Forward current (Average)	I _{F(AV)}	500	mA	
Non-repetitive peak forward surge current *	I_{FSM}	3	A	
Junction temperature	T_j	125	°C	
Storage temperature	T _{stg}	-55 to +125	°C	

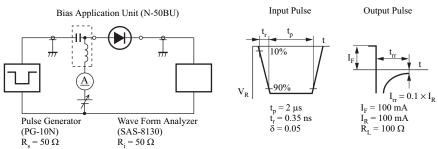




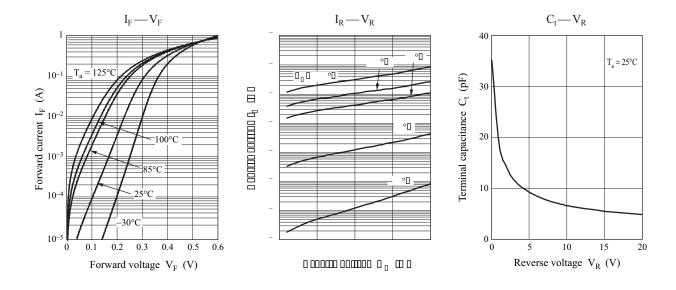
■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V_{F1}	$I_F = 10 \text{ mA}$			0.3	V
	V_{F2}	$I_F = 500 \text{ mA}$			0.5	V
Reverse current	I_R	$V_R = 10 \text{ V}$			30	μΑ
Terminal capacitance	C _t	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$		7		pF
Reverse recovery time *	t _{rr}	$\begin{aligned} I_F &= I_R = 100 \text{ mA}, I_{rr} = 0.1 \times I_R, \\ R_L &= 100 \Omega \end{aligned}$		2.4		ns

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 400 MHz
 - *: t_{rr} measurement circuit



Panasonic

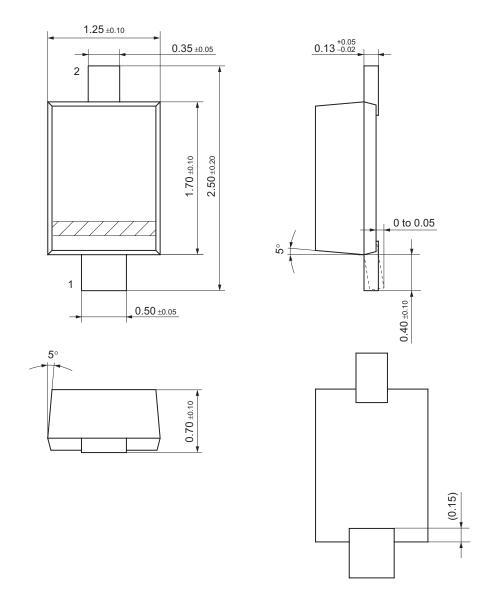


DB2J209

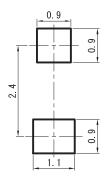
2 Ver. CED

SMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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